

Application Serial No: 10/790,339  
Attorney Docket No.: 51910-CIP (ACT-115-CIP, R&H 04-02CIP)

**Amendments to the Specification:**

Please replace paragraph [0023] on page 4 with the following rewritten paragraph:

-[0023] FIG. 10 shows FIGS. 10a-b show an embodiment of the present invention where the dielectric layer is enclosed with conductive polysilicon; and--

Please replace paragraph [0023] on page 4 with the following rewritten paragraph:

--[0041] Alternatively, a conductive layer is deposited before the dielectric layer 50 is deposited so that the cantilever 20 is completely enclosed by conductive polysilicon. FIG. 10 shows FIGS. 10a-b show a cross sectional view of a cantilever completely enclosed by polysilicon.--